

### **New Product**

Si7431DP

RoHS

COMPLIANT

Vishay Siliconix

# P-Channel 200-V (D-S) MOSFET

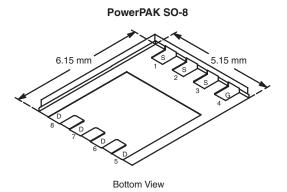
PRODUCT SUMMARY					
V <sub>DS</sub> (V)	r <sub>DS(on)</sub> (Ω)	I <sub>D</sub> (A)	Q <sub>g</sub> (Тур)		
-200	$0.174 @ V_{GS} = -10 V$	-3.8	88		
	0.180 @ V <sub>GS</sub> = -6 V	-3.6	00		

#### **FEATURES**

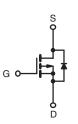
- TrenchFET<sup>®</sup> Power MOSFETS
- Ultra-Low On-Resistance Critical for Application
- Low Thermal Resistance PowerPAK<sup>®</sup> Package with Low 1.07-mm Profile
- 100 %  $R_{\alpha}$  and Avalanche Tested

#### **APPLICATIONS**

• Active Clamp in Intermediate DC/DC Power Supplies



Ordering Information: Si7431DP-T1-E3



P-Channel MOSFET

ABSOLUTE MAXIMUM RATINGS $T_A$	= 25 °C, unles	ss otherwise r	noted		
Parameter		Symbol	10 secs	Steady State	Unit
Drain-Source Voltage		V <sub>DS</sub>	-200		V
Gate-Source Voltage		V <sub>GS</sub>	±20		
Continuous Proin Current (T 150°C)8	T <sub>A</sub> = 25°C	I-	-3.8	-2.2	
Continuous Drain Current (T <sub>J</sub> = 150°C) <sup>a</sup>	T <sub>A</sub> = 70°C	D	-3.0	-1.8	
Pulsed Drain Current		I <sub>DM</sub>	-30		А
Continuous Source Current (Diode Conduction) <sup>a</sup>		۱ <sub>S</sub>	-4.2	-1.6	~
Single Pulse Avalanche Current	L = 1.0 mH	I <sub>AS</sub>	-30		
Single Pulse Avalanche Energy		E <sub>AS</sub>	45		
Mauinum Dauran Diasinatiana	$\frac{T_A = 25^{\circ}C}{T_A = 70^{\circ}C} P_D$	5.4	1.9	W	
Maximum Power Dissipation <sup>a</sup>		۲D	3.4	1.2	vv
Operating Junction and Storage Temperature Range		T <sub>J</sub> , T <sub>stg</sub>	-55 to 150		°C
Soldering Recommendations (Peak Temperature) <sup>b,c</sup>		•	260		

THERMAL RESISTANCE RATINGS					
Parameter		Symbol	Typical	Maximum	Unit
Manimum lumation to Anabianta	$t \le 10 \text{ sec}$	R <sub>thJA</sub>	18	23	°C/W
Maximum Junction-to-Ambient <sup>a</sup>	Steady State		50	65	
Maximum Junction-to-Case (Drain)	Steady State	R <sub>thJC</sub>	1.0	1.5	

Notes

A Surface Mounted on 1" x 1" FR4 Board. b. See Solder Profile ( <u>http://www.vishay.com/ppg?73257</u>). The PowerPAK SO-8 is a leadless package. The end of the lead terminal is exposed copper (not plated) as a result of the singulation process in manufacturing. A solder fillet at the exposed copper tip cannot be guaranteed and is not required to ensure adequate bottom side solder interconnection. c. Rework Conditions: manual soldering with a soldering iron is not recommended for leadless components.

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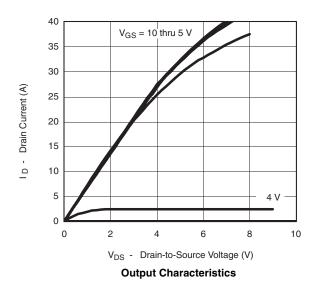


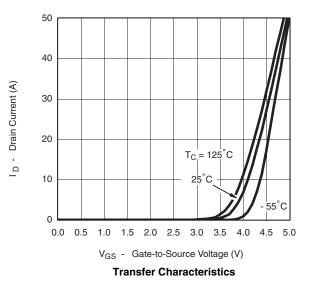
<b>SPECIFICATIONS</b> $T_J = 25$	°C, unless	otherwise noted				
Parameter	Symbol	Test Condition	Min	Тур	Max	Unit
Static						
Gate Threshold Voltage	V <sub>GS(th)</sub>	$V_{DS} = V_{GS}$ , $I_D = -250 \ \mu A$	-2.0		-4.0	V
Gate-Body Leakage	I <sub>GSS</sub>	$V_{DS} = 0 V, V_{GS} = \pm 20 V$			±100	nA
	I <sub>DSS</sub>	$V_{DS} = -200 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$			-1	۵
Zero Gate Voltage Drain Current		$V_{DS} = -200 \text{ V}, V_{GS} = 0 \text{ V}, T_{J} = 70^{\circ}\text{C}$				μΑ
On-State Drain Current <sup>a</sup>	I <sub>D(on)</sub>	$V_{DS} = -10 \text{ V}, V_{GS} = -10 \text{ V}$	-20			A
Drain-Source On-State Resistance <sup>a</sup>	r <sub>DS(on)</sub>	$V_{GS} = -10 \text{ V}, \text{ I}_{D} = -3.8 \text{ A}$		0.145	0.174	Ω
		$V_{GS} = -6 \text{ V}, \text{ I}_{D} = -3.6 \text{ A}$	$V_{GS} = -6 \text{ V}, \text{ I}_{D} = -3.6 \text{ A}$ 0.147		0.180	
Forward Transconductance <sup>a</sup>	9 <sub>fs</sub>	$V_{DS} = -15$ V, $I_{D} = -3.8$ A		17		S
Diode Forward Voltage <sup>a</sup>	V <sub>SD</sub>	$I_{S} = -4.2 \text{ A}, V_{GS} = 0 \text{ V}$		-0.78	-1.2	V
Dynamic <sup>b</sup>				•		
Total Gate Charge	Qg			88	135	
Gate-Source Charge	Q <sub>gs</sub>	$Q_{gs}$ $V_{DS} = -75$ V, $V_{GS} = -10$ V, $I_D = -5.2$ A		16.5		nC
Gate-Drain Charge	Q <sub>gd</sub>			25		
Gate Resistance	R <sub>g</sub>		1.5	3	4.5	Ω
Turn-On Delay Time	t <sub>d(on)</sub>			23	40	
Rise Time	t <sub>r</sub>	$V_{DD}$ = -75 V, $R_L$ = 15.5 $\Omega$		49	75	
Turn-Off Delay Time	t <sub>d(off)</sub>	$\text{I}_{\text{D}}\cong-4.8$ A, $\text{V}_{\text{GEN}}$ = –10 V, $\text{R}_{\text{G}}$ = 6 $\Omega$		110	180	ns
Fall Time	t <sub>f</sub>			66	100	
Source-Drain Reverse Recovery Time	t <sub>rr</sub>	I <sub>F</sub> = -2.9 A, di/dt = 100 A/µs		75	120	

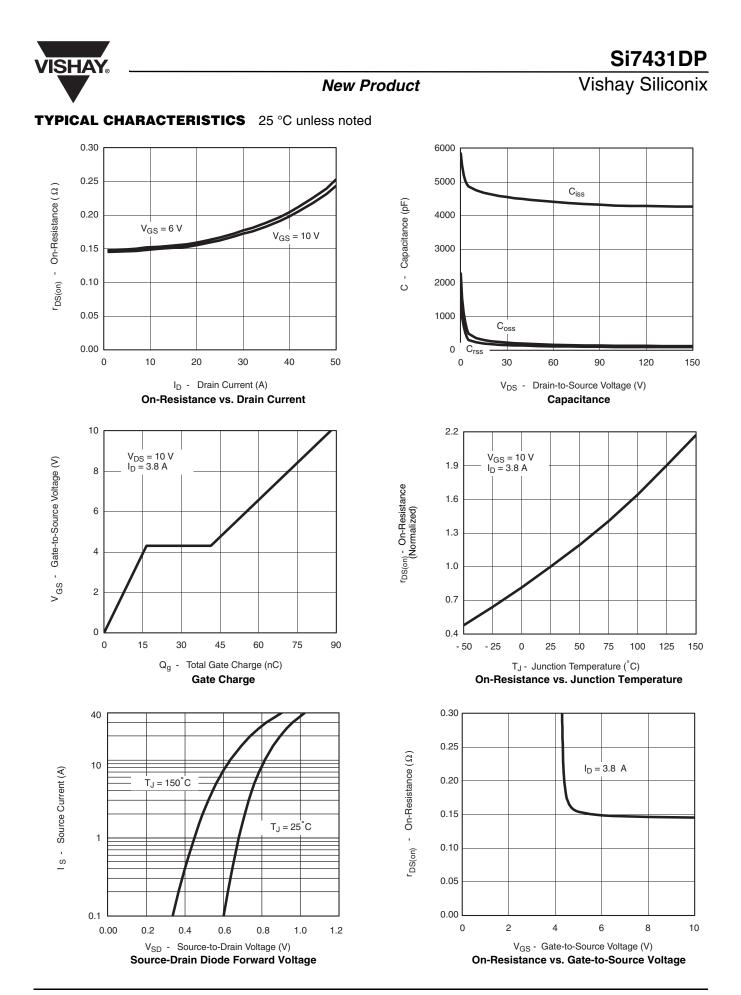
Notes a. Pulse test; pulse width  $\leq$  300 µs, duty cycle  $\leq$  2 %. b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

### TYPICAL CHARACTERISTICS 25 °C unless noted







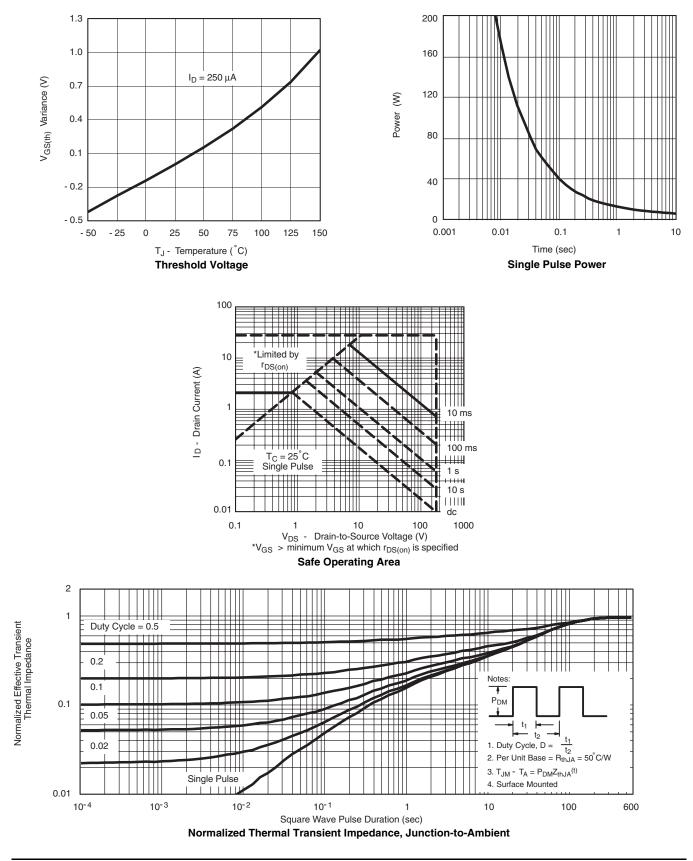
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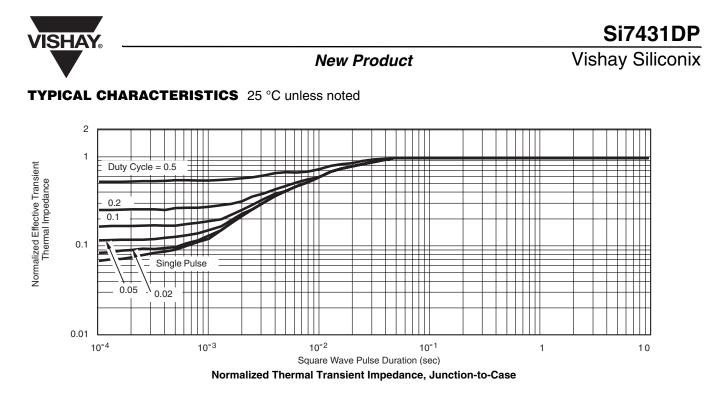
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